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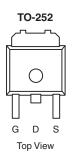
N-Channel 250-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)		
250	0.165 at V _{GS} = 10 V	16		

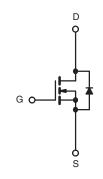
FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature





Drain Connected to Tab



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25$	5 °C, unless othe	rwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	250	- v		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C	L	16		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	I _D	9.8		
Pulsed Drain Current	I _{DM}	20	A		
Continuous Source Current (Diode Conduction)	۱ _S	16			
Single Pulse Avalanche Current	I _{AS}	5			
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	1.25	mJ	
Maximum Power Dissipation	T _C = 25 °C	PD	136 ^b	w	
	T _A = 25 °C	' D	3 ^a	vv	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	R _{thJA}	15	18	°C/W	
Junction-to-Ambient ^a	Steady State		40	50		
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1		

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.

b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min	Тур ^а	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	250			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	50 μΑ	
		V_{DS} = 250 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}$	16			А	
		V _{GS} = 10 V, I _D = 14 A	0.131 0.165		0.165		
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = 10 V, I _D = 14 A, T _J = 125 °C			0.347	Ω	
		V_{GS} = 10 V, I _D = 14 A, T _J = 175 °C			0.462		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 16 A		36		S	
Dynamic ^a							
Input Capacitance	C _{iss}			1950		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		160			
Reverse Transfer Capacitance	C _{rss}			70			
Total Gate Charge ^c	Qg			30	42	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 125 V, V_{GS} = 10 V, I_{D} = 16 A		10			
Gate-Drain Charge ^c	Q _{gd}			10			
Gate Resistance	Rg			1.6		Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 125 V, R_L = 7.35 Ω		130	195		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 16 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		30	45	ns	
Fall Time ^c	t _f			100	150		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C)			<u> </u>		
Pulsed Current	I _{SM}				20	А	
Diode Forward Voltage ^b	V _{SD}	I _F = 16 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 16 A, di/dt = 100 A/μs		115	175	ns	
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Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

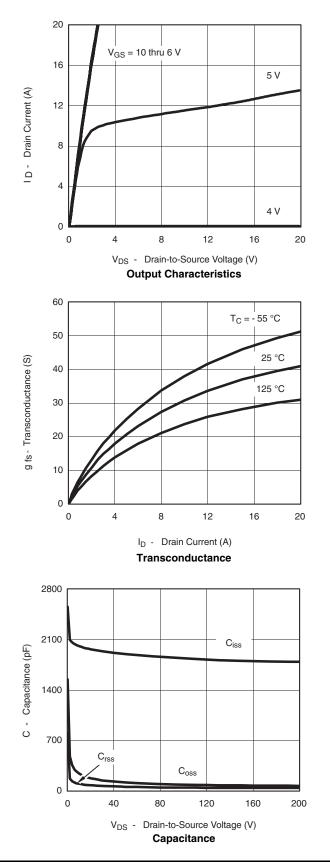
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

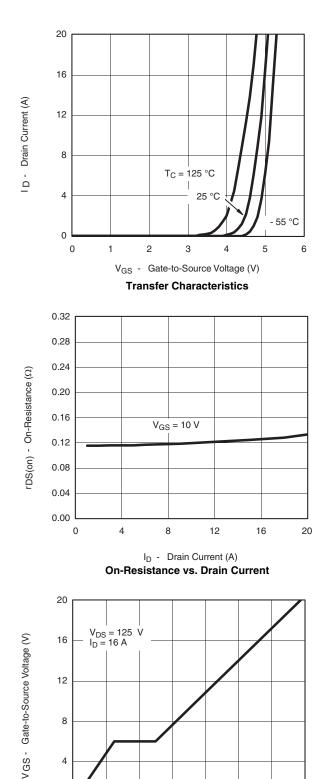


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TYPICAL CHARACTERISTICS 25 °C unless noted





Qg - Total Gate Charge (nC)

Gate Charge

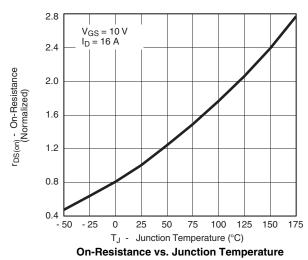
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T_J = 25 °C

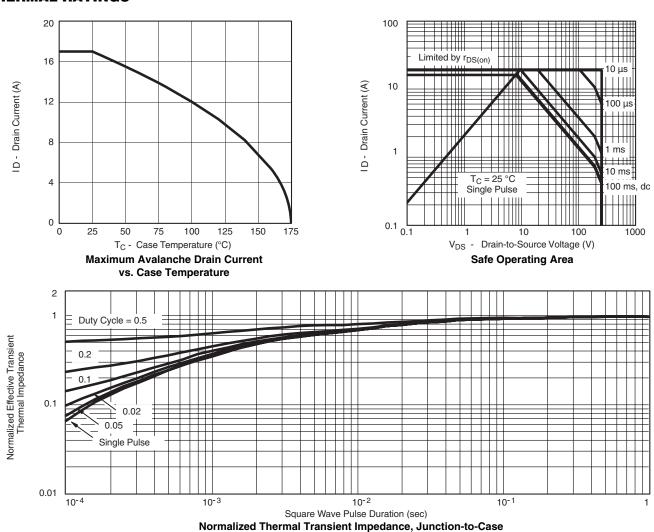
1.2

0.9



TYPICAL CHARACTERISTICS 25 °C unless noted

THERMAL RATINGS



100

10

1

0

. T_J = 150 °C

0.3

0.6

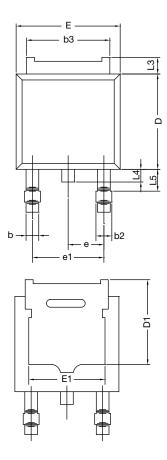
Source-Drain Diode Forward Voltage

V_{SD} - Source-to-Drain Voltage (V)

I S - Source Current (A)









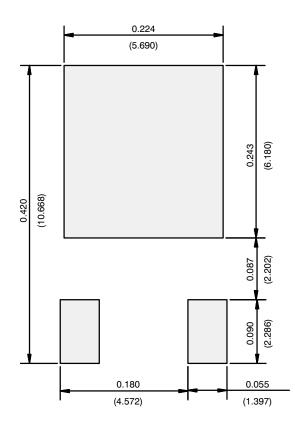
	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12- DWG: 534	0247-Rev. M,	24-Dec-12			

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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